

WS1A3640

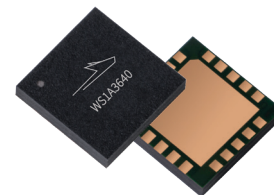
GaN on SiC Power Amplifier Module for 5G

Description

The WS1A3640 is an Asymmetric Doherty Power Amplifier Module (PAM) integrating Wolfsp speed GaN on SiC HEMT transistors with matching and biasing networks on a multilayer laminate substrate with advanced heat sinking technology. The WS1A3640 has been designed to operate from 3300 MHz to 3800 MHz, from supply voltages up to 50 V, at average output power levels of 8 to 10 W with crest-factor reduced and digitally pre-distorted LTE and 5G NR signals with instantaneous bandwidths of 200 MHz or more. The device is housed in a 6 mm X 6 mm land grid array (LGA) package.

Features

- GaN on SiC technology
- Frequency: 3300-3800 MHz
- Average Output Power: 39.5 dBm
- $P_{SAT} = 48$ dBm
- RF inputs matched to 50 Ω and DC matched blocked
- Gate bias supply for main and peak sides available from either side of device
- Integrated harmonic terminations
- Pb-free and RoHS compliant



WS1A3640
Package PG-LGA-6x6-3-1

Typical Broadband Performance

Single-carrier LTE Performance (tested in Wolfsp speed applications circuit for 3400 – 3800 MHz)

$V_{DD} = 48$ V, $I_{DQ(main)} = 70$ mA, $V_{GS(peak)} = -5$ V, channel bandwidth = 18.015 MHz, input PAR = 10 dB @ 0.01% CCDF

	P_{OUT} (dBm)	Gain (dB)	Efficiency (%)	ACPR – (dBc)	ACPR + (dBc)	PAR (dB)
3400 MHz	39.5	13.5	49.6	-25	-26	8.0
3600 MHz	39.5	13.0	51.0	-32	-33	8.4
3800 MHz	39.5	12.5	50.0	-35	-36	7.8

All published data at $T_{CASE} = 25^{\circ}C$ unless otherwise indicated





Maximum Ratings at T_{CASE} = 25 °C

Parameter		Symbol	Value	Unit
Drain-source Voltage		V _{DSS}	125	V
Gate-source Voltage		V _{GS}	-10 to +2	V
Operating Voltage		V _{DD}	55	V
RF Input Power (main)	Pulse CW, 10% duty cycle, 20 μs pulse width	P _{IN}	35.5	dBm
(peak)		P _{IN}	38.5	dBm
Case Temperature		T _C	135	°C
Storage Temperature Range		T _{STG}	-65 to +150	°C

Operation above the maximum values listed here may cause permanent damage. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the component. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. For reliable continuous operation, the device should be operated within the operating voltage range (V_{DD}) specified above.

DC Characteristics

Characteristics	Conditions	Symbol	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage (main)	V _{GS} = -8 V, I _D = 3.4 mA	V _{(BR)DSS}	150	—	—	V
(peak)	V _{GS} = -8 V, I _D = 5.6 mA	V _{(BR)DSS}	150	—	—	V
Gate Leakage Current	V _{GS} = -8 V, V _{DS} = 50 V	I _{GSS}	—	—	-1.5	mA
Gate Threshold Voltage (main)	V _{DS} = 10 V, I _D = 3.4 mA	V _{GS(th)}	-3.8	-3.0	-2.3	V
(peak)	V _{DS} = 10 V, I _D = 5.6 mA	V _{GS(th)}	-3.8	-3.0	-2.3	V

Recommended Operating Conditions

Parameter	Conditions	Symbol	Min	Typ	Max	Unit
Operating Voltage		V _{DD}	0	—	50	V
Gate Quiescent Voltage (main)	V _{DS} = 48 V, I _D = 30 mA	V _{GS(Q)}	-3.6	-3.1	-2.6	V
(peak)	V _{DS} = 48 V, I _D = 40 mA	V _{GS(Q)}	-3.6	-3.1	-2.6	V

Moisture Sensitivity Level

Level	Test Standard	Package Temperature	Unit
3	IPC/JEDEC J-STD-020	260	°C

ESD Characteristics

Parameter	Class	Standard
Human Body Model (HBM)	Class 1B	ANSI/ESDA/JEDEC JS-001
Charge Device Model (CDM)	Class 3C	ANSI/ESDA/JEDEC JS-002



RF Characteristics (tested in Wolfspeed production test fixture)

$V_{DD} = 48$ V, Pulse CW 10% duty cycle, 20 μ s pulse width

Parameter	Symbol	Conditions	Main		Peak		Unit
			Min	Max	Min	Max	
3500 MHz							
Gain	G	$P_{OUT} = 38$ dBm (main) $P_{OUT} = 40$ dBm (peak)	14	18	13	17	dB
Saturated Power	P_{SAT}	$I_{DQ} = 30$ mA (main) $I_{DQ} = 40$ mA (peak)	42	-	45	-	dBm
Efficiency	Eff	$I_{DQ} = 30$ mA, P_{SAT}	41	-	41	-	%
3700 MHz							
Gain	G	$P_{OUT} = 38$ dBm (main) $P_{OUT} = 40$ dBm (peak)	13	17.5	12	17	dB
Saturated Power	P_{SAT}	$I_{DQ} = 30$ mA (main) $I_{DQ} = 40$ mA (peak)	42	-	44	-	dBm
Efficiency	Eff	$I_{DQ} = 30$ mA, P_{SAT}	48	-	44	-	%

Ordering Information

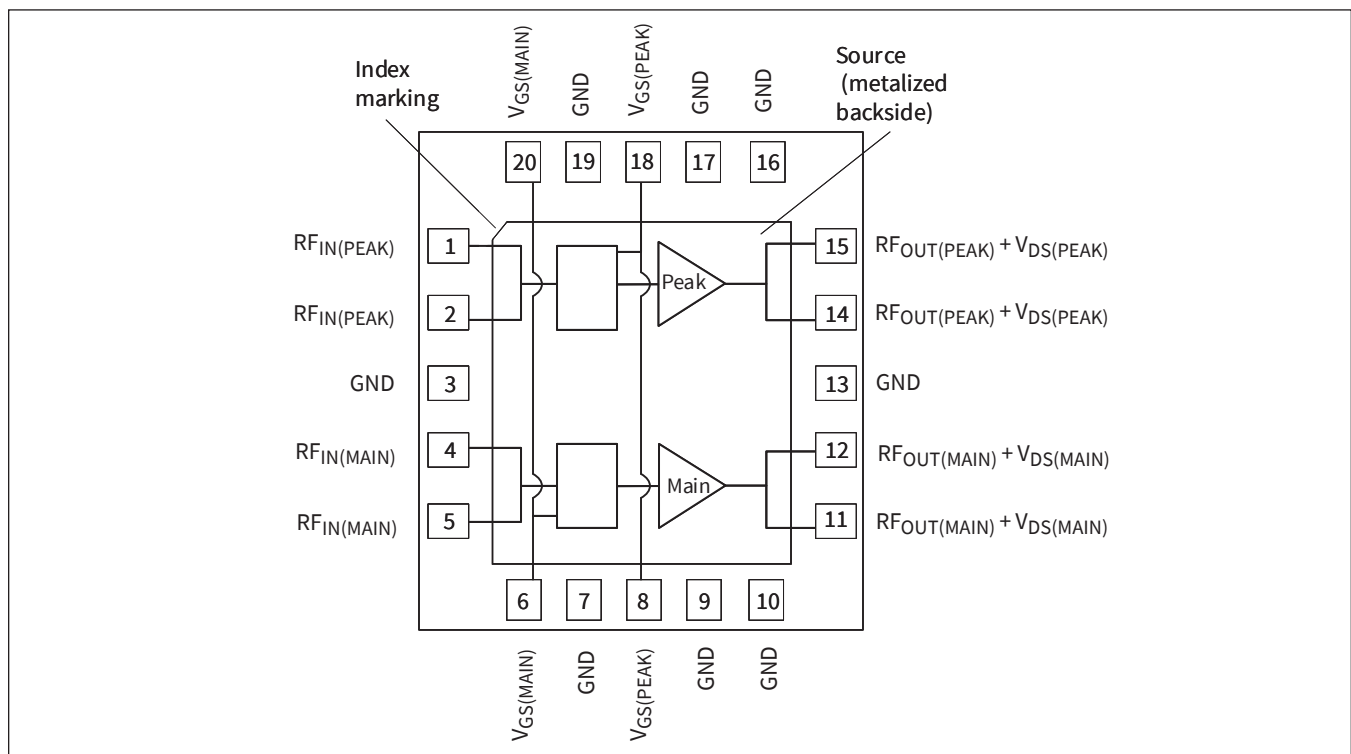
Order Code	Description
WS1A3640-V2-R00A	Sample Quantities
WS1A3640-V2-R1	330 mm (13") Reel 100 pcs
WS1A3640-V2-R3K	330 mm (13") Reel 3,000 pcs
FXA/WS1A3640V2-08	3.3-3.6 GHz WS1A3640 Evaluation Board
FXA/WSGPA01V1-14	3.3-3.6 GHz WSGPA01 Evaluation Board
FXL/WS1A3640V2-01	3.4-3.6 GHz Evaluation Board (WSGPA01 + WS1A3640)
FXL/WS1A3640V2-03	3.6-3.8 GHz Evaluation Board (WSGPA01 + WS1A3640)
FXL/WS1A3640V2-02	3.4-3.8 GHz Evaluation Board (WSGPA01 + WS1A3640)



Evaluation Boards - Typical RF Performance

Part Number	Frequency	P _{OUT} (dBm)	Eff (%)	Gain (dB)	PAR (dB)	ACPR+ (dBc)	ACPR- (dBc)
Output Stage : WS1A3640							
Single-carrier LTE Performance, V _{DD} = 48 V, I _{DQ(main)} = 70 mA, channel bandwidth = 18.015 MHz, input PAR = 10 dB @ 0.01% CCDF							
FXA/WS1A3640P1.2.4-08	3.3-3.6 GHz	39.5	53	13.5	8.2	-28	-28
WSGPA01 Driver							
Single-carrier WCDMA Performance, V _{DD} = 48 V, I _{DQ} = 25 mA, channel bandwidth = 3.84 MHz, input PAR = 10 dB @ 0.01% CCDF							
FXA/WSGPA01V1-14	3.3-3.6 GHz	26.5	18	16	8.9	-45.1	-45.8
Board with Integrated WSGPA01 Driver and WS1A3640 Output Stage							
Single-carrier WCDMA Performance, V _{DD} = 48 V, I _{DQ} = 70 mA, I _{DQ(driver)} = 25 mA, channel bandwidth = 3.84 MHz, input PAR = 10 dB @ 0.01% CCDF							
FXL/WS1A3640V2-01	3.4-3.6 GHz	39.5	48	29	8.0	-28	-28
FXL/WS1A3640V2-03	3.6-3.8 GHz	39.5	46	29	8.0	-31	-31
FXL/WS1A3640V2-02	3.4-3.8 GHz	39.5	45	29	8.0	-31	-31

Pinout Diagram (top view)

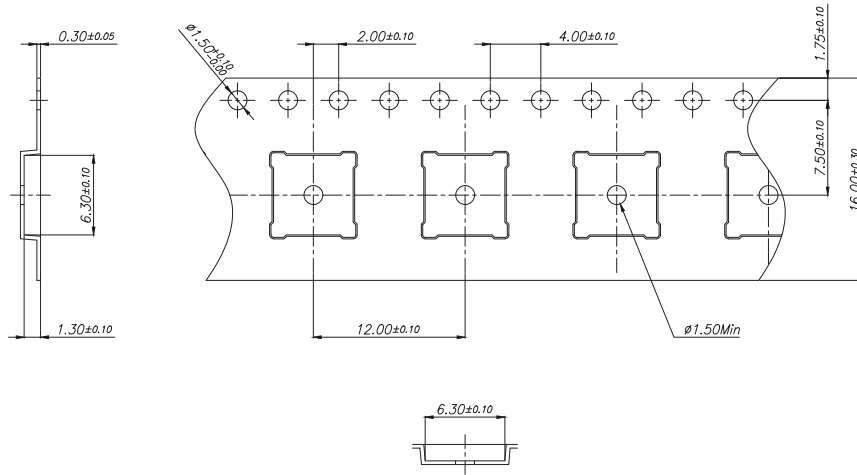


Bias Sequencing

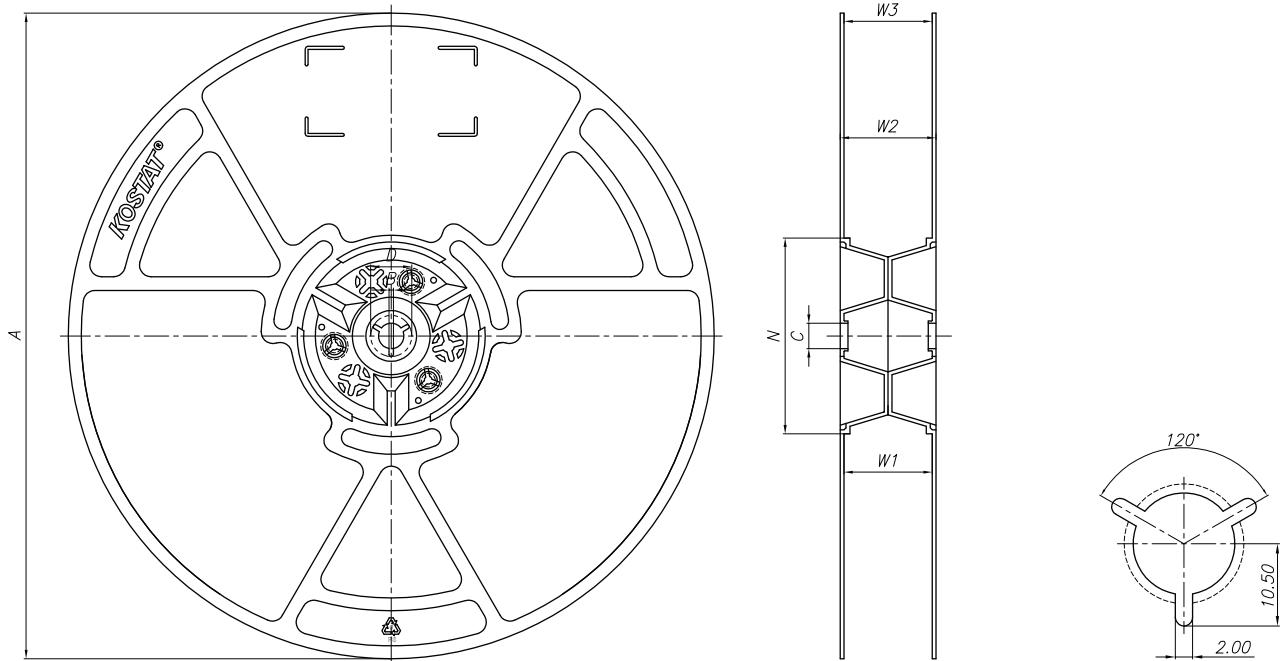
Bias ON	Bias OFF
1. Ensure RF is turned off	1. Turn RF off
2. Apply pinch-off voltage of -5 V to the gate	2. Apply pinch-off voltage to the gate
3. Apply nominal drain voltage	3. Turn-off drain voltage
4. Bias gate to desired quiescent drain current	4. Turn-off gate voltage
5. Apply RF	



Tape and Reel Information



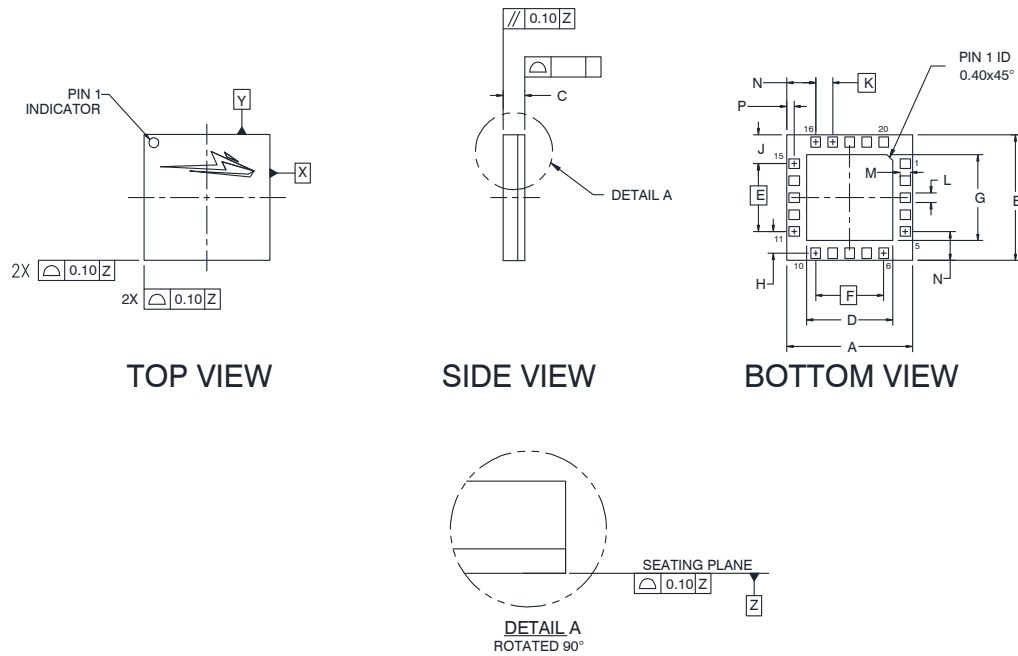
- (I) 10 sprocket hole pitch cumulative tolerance ± 0.20
 - (II) Camber not to exceed 1 mm in 250 mm
 - (III) Material : Black conductive Polystyrene
 - (IV) Ao and Bo measured on a plane 0.3 mm above the bottom of the pocket.
 - (V) Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier
 - (VI) Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole
- ALL DIMENSIONS IN MILLIMETERS UNLESS OTHERWISE STATED.



Size	A	B	C	D	N	W1	W2	W3
16mm	330 ^{+2.0} _{-2.0}	1.5min	13.0 ^{+0.5} _{-0.2}	20.2 min	100 ^{+3.0} _{-0.0}	16.4 ^{+2.0} _{-0.0}	20.4 ^{+2.0} _{-2.0}	17.65 ^{+1.75} _{-1.75}



Package Outline Specifications-Package PG-LGA-6x6-3-1



DIM	INCHES			MILLIMETERS		
	MIN	TYP	MAX	MIN	TYP	MAX
A	.234	.236	.238	5.95	6.00	6.05
B	.234	.236	.238	5.95	6.00	6.05
C	.037	.041	.045	0.93	1.03	1.13
D	.157	.161	.165	4.00	4.10	4.20
E	—	.128	—	—	3.24	—
F	—	.128	—	—	3.24	—
G	—	.161	—	—	4.10	—
H	—	.041	—	—	1.03	—
J	.054	.054	.055	1.37	1.38	1.39
K	—	.032	—	—	0.81	—
L	—	.018	—	—	0.46	—
M	—	.020	—	—	0.50	—
N	.054	.054	.055	1.37	1.38	1.39
P	.013	.014	.014	0.34	0.35	0.36

Diagram Notes—unless otherwise specified:

1. Interpret dimensions and tolerances per ASME Y14.5M-1994.